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(54) **ELECTRONIC DEVICE ASSEMBLY WITH COMPRESSION GASKET**

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CPC ***G06F 1/203*** (2013.01); ***G06F 1/1658*** (2013.01); ***H05K 9/0026*** (2013.01)

(58) **Field of Classification Search**

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See application file for complete search history.

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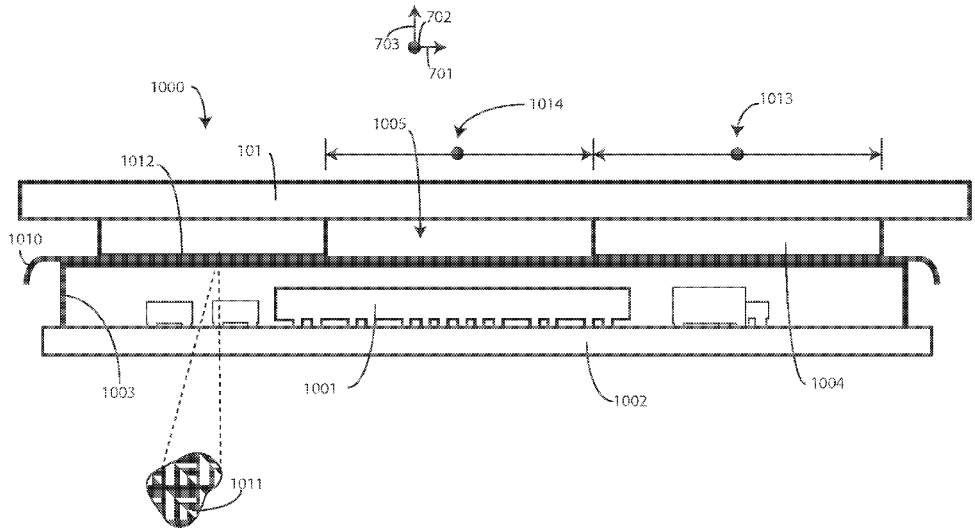
(57) **ABSTRACT**

An assembly (**1000**) includes a substrate (**1002**) and a heat emissive electrical component (**1001**) disposed on the substrate. A shield (**1003**) is disposed on the substrate, thereby enclosing the heat emissive electrical component. A display assembly (**101**) is disposed above the shield. A compressible pad (**1004**) is disposed between the shield and the display assembly. The compressible pad defines an aperture (**1005**) above the heat emissive electrical component. The aperture can have dimensions that are a function of a shield area and a heat emissive electrical component area.

19 Claims, 12 Drawing Sheets